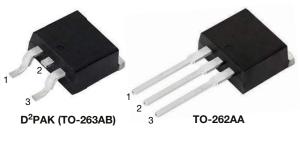
VS-20CTQ...S-M3, VS-20CTQ...-1-M3 Series

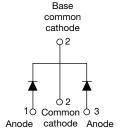
Vishay Semiconductors

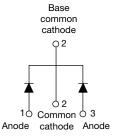
HALOGEN

FREE

High Performance Schottky Rectifier, 2 x 10 A







VS-20CTQ...S-M3

VS-20CTQ...-1-M3

PRIMARY CHARACTERISTICS						
I _{F(AV)}	2 x 10 A					
V _R	35 V, 40 V, 45 V					
V _F at I _F	0.57 V					
I _{RM}	15 mA at 125 °C					
T _J max.	175 °C					
E _{AS}	13 mJ					
Package	D ² PAK (TO-263AB), TO-262AA					
Circuit configuration	Common cathode					

FEATURES

- 175 °C T_J operation
- Center tap configuration
- Low forward voltage drop
- High frequency operation
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION

The VS-20CTQ... center tap Schottky rectifier series has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 175 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS								
SYMBOL	VALUES	UNITS						
I _{F(AV)}	Rectangular waveform	20	Α					
V _{RRM}	Range	35 to 45	V					
I _{FSM}	$t_p = 5 \mu s \text{ sine}$	1060	Α					
V _F	10 A _{pk} , T _J = 125 °C (per leg)	0.57	V					
TJ	Range	-55 to +175	°C					

VOLTAGE RATINGS							
PARAMETER SYMBOL VS-20CTQ035S-M3 VS-20CTQ040S-M3 VS-20CTQ045S-M3 VS-20CTQ045-1-M3 VS-20CTQ0							
Maximum DC reverse voltage	V_{R}	35	40	45	V		
Maximum working peak reverse voltage	V_{RWM}	33	40	40	V		



VS-20CTQ...S-M3, VS-20CTQ...-1-M3 Series

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ABSOLUTE MAXIMUM RATINGS									
PARAMETER	SYMBOL	TEST COND	ITIONS	VALUES	UNITS				
Maximum average forward current See fig. 5	I _{F(AV)}	50 % duty cycle at T _C = 145 °C	20						
Maximum peak one cycle non-repetitive	I _{FSM}	5 μs sine or 3 μs rect. pulse	Following any rated load condition and with rated	1060	Α				
surge current per leg See fig. 7		10 ms sine or 6 ms rect. pulse	265						
Non-repetitive avalanche energy per leg	E _{AS}	$T_J = 25 ^{\circ}\text{C}$, $I_{AS} = 2.0 \text{A}$, $L = 6.5 \text{mH}$		13	mJ				
Repetitive avalanche current per leg	I _{AR}	Current decaying linearly to zer Frequency limited by T _J maxim	2.0	Α					

ELECTRICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CO	TEST CONDITIONS					
		10 A	T _{.1} = 25 °C	0.64				
Maximum forward voltage drop per leg See fig. 1	V _{FM} ⁽¹⁾	20 A	1j=25 C	0.76	V			
		10 A	T 105 °C	0.57				
		20 A	T _J = 125 °C	0.68				
Maximum reverse leakage current per leg	. (1)	T _J = 25 °C	V Dated V	2	A			
See fig. 2	I _{RM} ⁽¹⁾	T _J = 125 °C	V_R = Rated V_R	15	mA			
Maximum junction capacitance per leg	C _T	V _R = 5 V _{DC} (test signal range 100 kHz to 1 MHz), 25 °C		900	pF			
Typical series inductance per leg	L _S	Measured lead to lead 5 mm from package body		8.0	nΗ			
Maximum voltage rate of change	dV/dt	Rated V _R		10 000	V/µs			

Note

 $^{^{(1)}\,}$ Pulse width < 300 $\mu s,$ duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum junction and stora temperature range	ge	T _J , T _{Stg}		-55 to 175	°C		
Maximum thermal resistance junction to case per leg),	- R _{th.JC}	DC operation See fig. 4	3.25			
	Maximum thermal resistance, junction to case per package		DC operation	1.63	°C/W		
Typical thermal resistance, case to heatsink		R _{thCS}	Mounting surface, smooth and greased	0.50			
Approximate weight				2	g		
Approximate weight				0.07	OZ.		
Marinting toward	minimum			6 (5)	kgf · cm		
Mounting torque	maximum			12 (10)	(lbf · in)		
			Case style D ² PAK (TO-263AB)	20CTC 20CTC 20CTC	Q040S		
			Case style TO-262AA	20CTC 20CTC 20CTC	040-1		

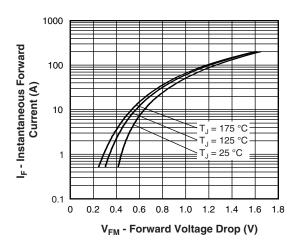


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

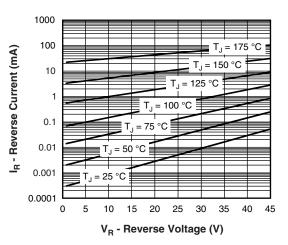


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

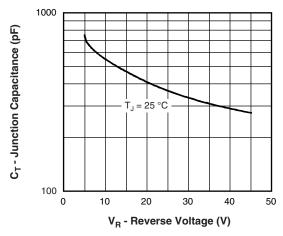


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

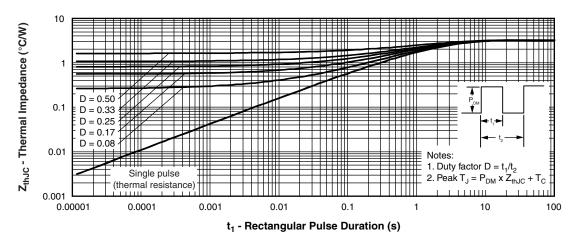


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics (Per Leg)

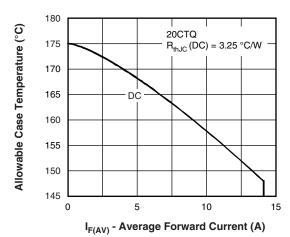


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

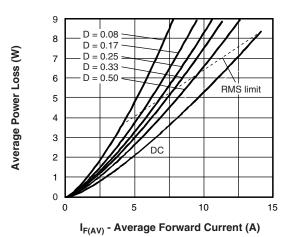


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

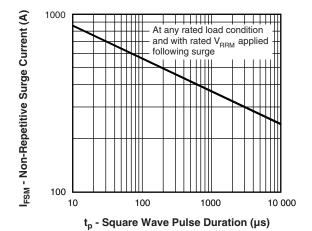


Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

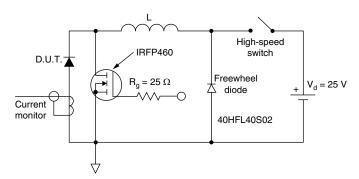


Fig. 8 - Unclamped Inductive Test Circuit

Note

(1) Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$;

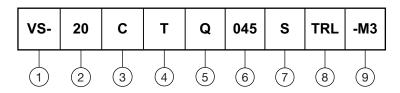
VS-20CTQ...S-M3, VS-20CTQ...-1-M3 Series

Vishay Semiconductors

Pd = forward power loss = $I_{F(AV)}$ x V_{FM} at ($I_{F(AV)}$ /D) (see fig. 6); Pd_{REV} = inverse power loss = V_{R1} x I_{R} (1 - D); I_{R} at V_{R1} = 80 % rated V_{R} applied

ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Current rating (20 A)

- Circuit configuration: C = common cathode

4 - T = TO-220

Schottky "Q" series

035 = 35 V

6 - Voltage ratings —

040 = 40 V

S = D²PAK (TO-263AB)

045 = 45 V

• -1 = TO-262AA

8 - • None = tube

• TRL = tape and reel (left oriented - for D²PAK (TO-263AB) only)

• TRR = tape and reel (right oriented - for D²PAK (TO-263AB) only)

9 - -M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free

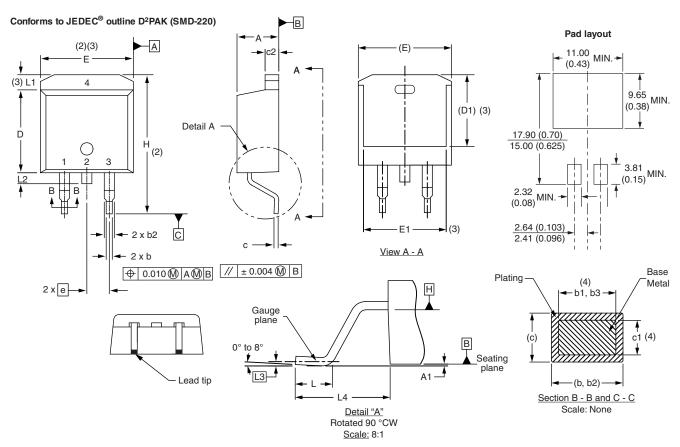
ORDERING INFORMATION		
PREFERRED P/N	BASE QUANTITY	PACKAGING DESCRIPTION
VS-20CTQ035S-M3	50	Antistatic plastic tubes
VS-20CTQ035STRL-M3	800	13" diameter plastic tape and reel
VS-20CTQ035STRR-M3	800	13" diameter plastic tape and reel
VS-20CTQ040S-M3	50	Antistatic plastic tubes
VS-20CTQ040STRL-M3	50	13" diameter plastic tape and reel
VS-20CTQ040STRR-M3	800	13" diameter plastic tape and reel
VS-20CTQ045S-M3	800	Antistatic plastic tubes
VS-20CTQ045STRL-M3	50	13" diameter plastic tape and reel
VS-20CTQ045STRR-M3	50	13" diameter plastic tape and reel
VS-20CTQ150S-M3	800	Antistatic plastic tubes
VS-20CTQ150STRL-M3	800	13" diameter plastic tape and reel
VS-20CTQ150STRR-M3	50	13" diameter plastic tape and reel
VS-20CTQ045-1-M3	50	Antistatic plastic tubes

LINKS TO RELATED DOCUMENTS						
Dimensions	D ² PAK (TO-263AB)	www.vishay.com/doc?96164				
Difficusions	TO-262AA	www.vishay.com/doc?96165				
Dort marking information	D ² PAK (TO-263AB)	www.vishay.com/doc?95444				
Part marking information	TO-262AA	www.vishay.com/doc?95443				
Packaging information		www.vishay.com/doc?96424				



D²PAK

DIMENSIONS in millimeters and inches



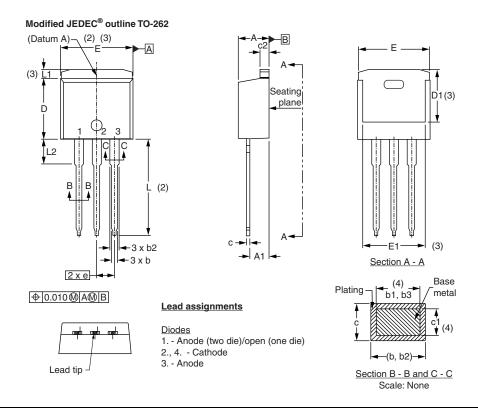
SYMBOL	MILLIMETERS		INC	HES	NOTES	S SYMBOL		MILLIM	ETERS	INC	HES	NOTES
STIVIBUL	MIN.	MAX.	MIN.	MAX.	NOIES	NOIES	STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190			D1	6.86	8.00	0.270	0.315	3
A1	0.00	0.254	0.000	0.010			Е	9.65	10.67	0.380	0.420	2, 3
b	0.51	0.99	0.020	0.039			E1	7.90	8.80	0.311	0.346	3
b1	0.51	0.89	0.020	0.035	4		е	2.54	BSC	0.100) BSC	
b2	1.14	1.78	0.045	0.070			Н	14.61	15.88	0.575	0.625	
b3	1.14	1.73	0.045	0.068	4		L	1.78	2.79	0.070	0.110	
С	0.38	0.74	0.015	0.029			L1	-	1.65	-	0.066	3
c1	0.38	0.58	0.015	0.023	4		L2	1.27	1.78	0.050	0.070	
c2	1.14	1.65	0.045	0.065			L3	0.25	BSC	0.010	BSC	
D	8.51	9.65	0.335	0.380	2		L4	4.78	5.28	0.188	0.208	

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch
- (7) Outline conforms to JEDEC® outline TO-263AB

TO-262

DIMENSIONS in millimeters and inches



SYMBOL	MILLIN	IETERS	INC	CHES	NOTES
STIVIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190	
A1	2.03	3.02	0.080	0.119	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
С	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
е	2.54	BSC	0.10	0 BSC	
L	13.46	14.10	0.530	0.555	
L1	-	1.65	-	0.065	3
L2	3.36	3.71	0.132	0.146	

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- 5) Controlling dimension: inches
- (6) Outline conform to JEDEC TO-262 except A1 (maximum), b (minimum), D1 (minimum) and L2 where dimensions derived the actual package outline

Revision: 11-Jul-2019 1 Document Number: 95419



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Vishay

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